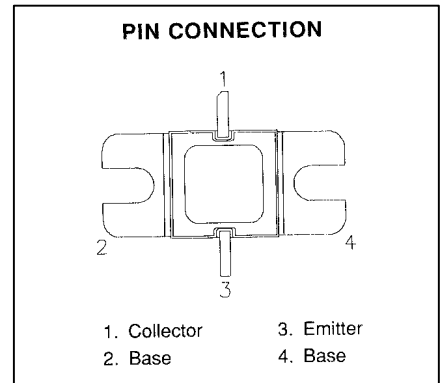
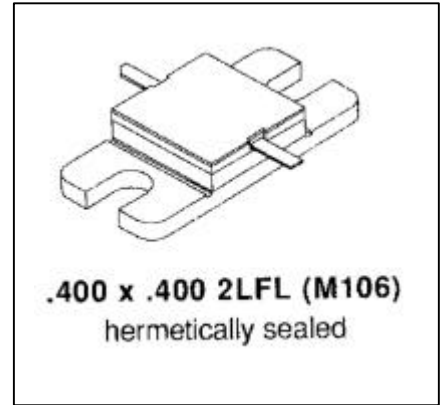


**MS2176**

**RF AND MICROWAVE TRANSISTORS  
UHF PULSED APPLICATIONS**

**Features**

- **350 WATTS @ 10μSEC PULSE WIDTH, 10% DUTY CYCLE**
- **300 WATTS @ 250μSEC PULSE WIDTH 10% DUTY CYCLE**
- **9.5 DB MIN. GAIN**
- **REFRACTORY GOLD METALLIZATION**
- **EMITTER BALLASTING AND LOW THERMAL RESISTANCE FOR RELIABILITY AND RUGGEDNESS**
- **INFINITE VSWR CAPABILITY AT SPECIFIED OPERATING CONDITIONS**



**DESCRIPTION:**

The MS2176 is a gold metallized silicon NPN pulse power transistor designed for applications requiring high peak power and low duty cycles within the frequency range of 400 – 500 MHz.

**ABSOLUTE MAXIMUM RATINGS (T<sub>case</sub> = 25°C)**

Symbol	Parameter	Value	Unit
<b>V<sub>CBO</sub></b>	<b>Collector-Base Voltage</b>	<b>65</b>	<b>V</b>
<b>V<sub>CES</sub></b>	<b>Collector-Emitter Voltage</b>	<b>65</b>	<b>V</b>
<b>V<sub>EBO</sub></b>	<b>Emitter-Base Voltage</b>	<b>3.5</b>	<b>V</b>
<b>I<sub>C</sub></b>	<b>Device Current</b>	<b>21.6</b>	<b>A</b>
<b>P<sub>DISS</sub></b>	<b>Power Dissipation</b>	<b>875</b>	<b>W</b>
<b>T<sub>J</sub></b>	<b>Junction Temperature</b>	<b>+200</b>	<b>°C</b>
<b>T<sub>STG</sub></b>	<b>Storage Temperature</b>	<b>-65 to +150</b>	<b>°C</b>

**Thermal Data**

<b>R<sub>TH(j-c)</sub></b>	<b>Junction-Case Thermal Resistance</b>	<b>0.2</b>	<b>°C/W</b>
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**ELECTRICAL SPECIFICATIONS (T<sub>case</sub> = 25°C)**
**STATIC**

Symbol	Test Conditions	Value			Units
		Min.	Typ.	Max.	
<b>BV<sub>CBO</sub></b>	<b>I<sub>C</sub> = 50 mA    I<sub>E</sub> = 0 mA</b>	<b>65</b>			<b>V</b>
<b>BV<sub>CES</sub></b>	<b>I<sub>C</sub> = 50 mA    V<sub>BE</sub> = 0 V</b>	<b>65</b>			<b>V</b>
<b>BV<sub>CEO</sub></b>	<b>I<sub>C</sub> = 50 mA    I<sub>B</sub> = 0 mA</b>	<b>28</b>			<b>V</b>
<b>BV<sub>EBO</sub></b>	<b>I<sub>E</sub> = 10 mA    I<sub>C</sub> = 0 mA</b>	<b>3.5</b>			<b>V</b>
<b>I<sub>CES</sub></b>	<b>V<sub>CE</sub> = 30 V    I<sub>E</sub> = 0 mA</b>			<b>7.5</b>	<b>mA</b>
<b>h<sub>FE</sub></b>	<b>V<sub>CE</sub> = 5 V    I<sub>C</sub> = 5 A</b>	<b>10</b>		<b>100</b>	

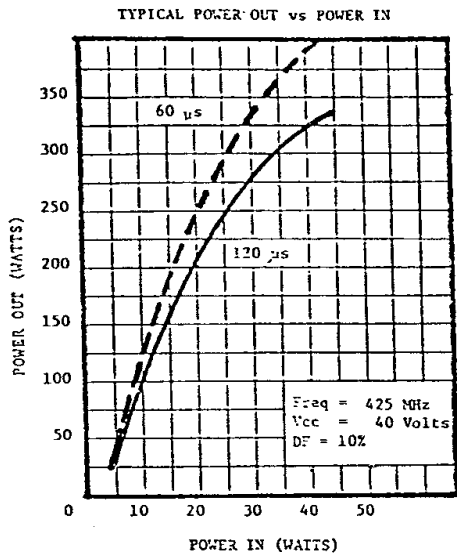
**DYNAMIC**

Symbol	Test Conditions	Value			Units
		Min.	Typ.	Max.	
<b>P<sub>OUT</sub></b>	<b>f = 425 MHz    P<sub>IN</sub> = 33.5 W    V<sub>CE</sub> = 40 V</b>	<b>300</b>			<b>W</b>
<b>G<sub>P</sub></b>	<b>f = 425 MHz    P<sub>IN</sub> = 300 W    V<sub>CE</sub> = 40 V</b>	<b>9.5</b>			<b>dB</b>
<b>ζ<sub>C</sub></b>	<b>f = 425 MHz    P<sub>IN</sub> = 25 W    V<sub>CE</sub> = 40 V</b>	<b>55</b>			<b>%</b>

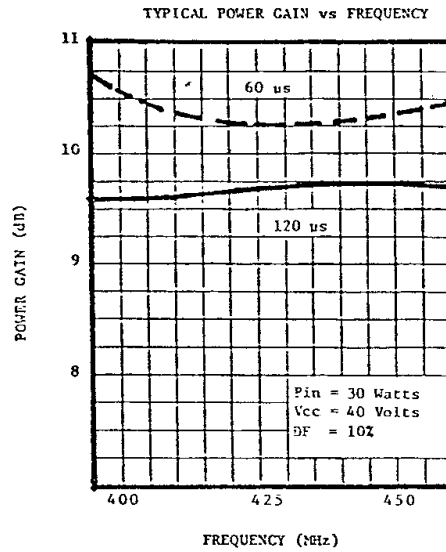
Note: Pulse Width = 250μSec, Duty Cycle = 10%

TYPICAL PERFORMANCE

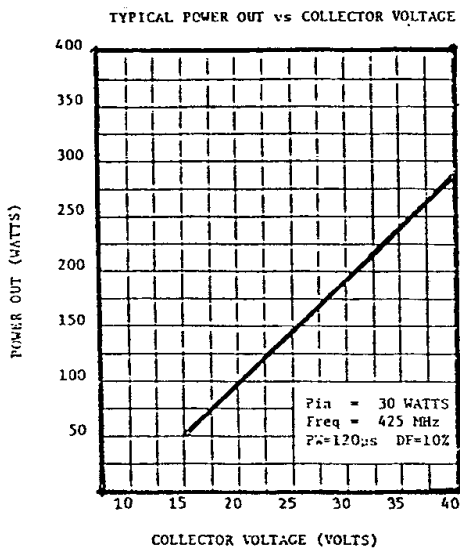
**POWER OUTPUT vs POWER INPUT**



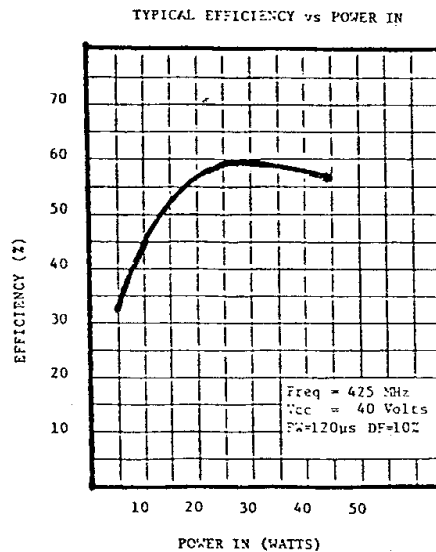
**POWER GAIN vs FREQUENCY**



**POWER OUTPUT vs COLLECTOR VOLTAGE**

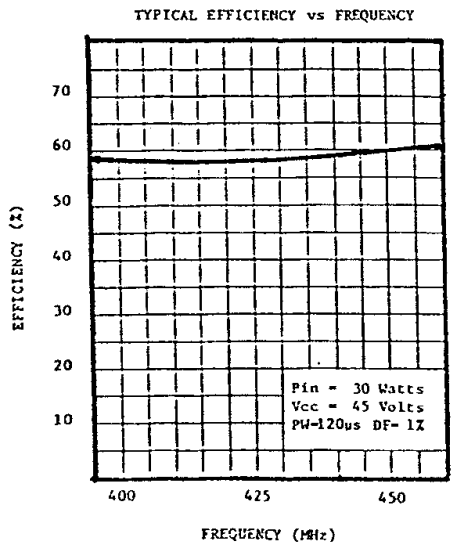


**EFFICIENCY vs POWER INPUT**

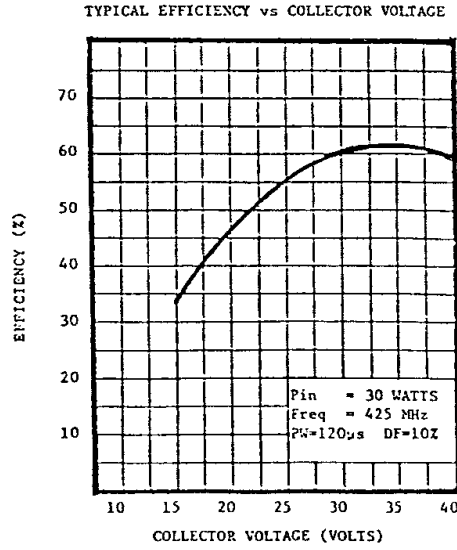


TYPICAL PERFORMANCE (CONTINUED)

**EFFICIENCY vs FREQUENCY**



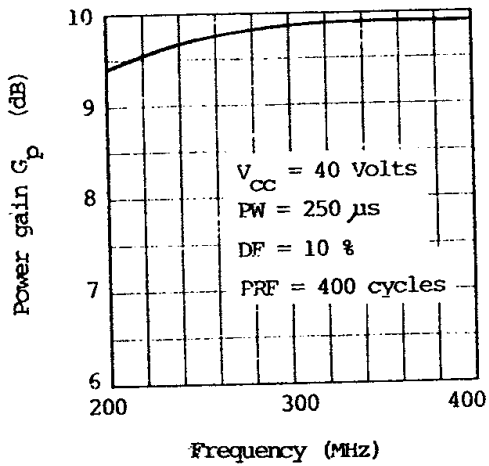
**EFFICIENCY vs COLLECTOR VOLTAGE**



TYPICAL PERFORMANCE (CONTINUED)

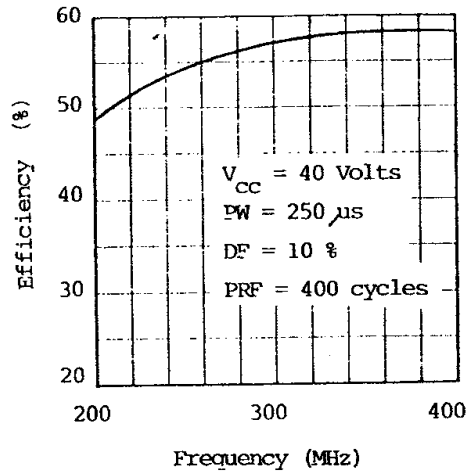
**POWER GAIN vs FREQUENCY**

TYPICAL POWER GAIN VS FREQUENCY



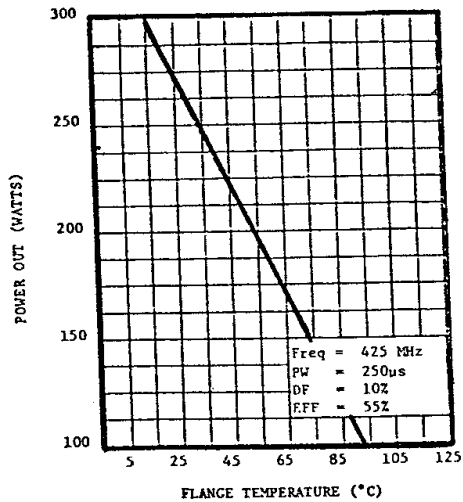
**EFFICIENCY vs FREQUENCY**

TYPICAL EFFICIENCY VS FREQUENCY



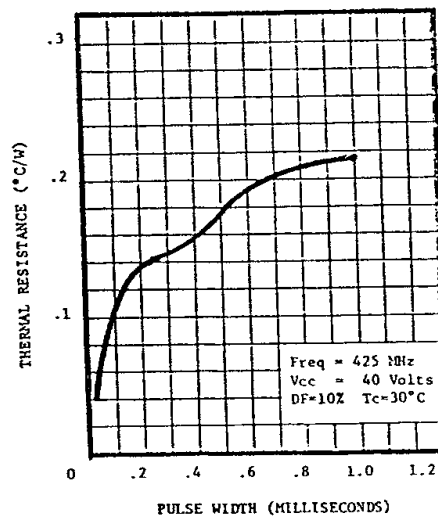
**POWER OUTPUT vs FLANGE  
T<sub>J</sub> @ CONSTANT 125°C**

TYPICAL POWER OUT vs FLANGE  
TEMPERATURE: T<sub>J</sub> AT CONSTANT 125°C  
PULSE WIDTH: 250μs



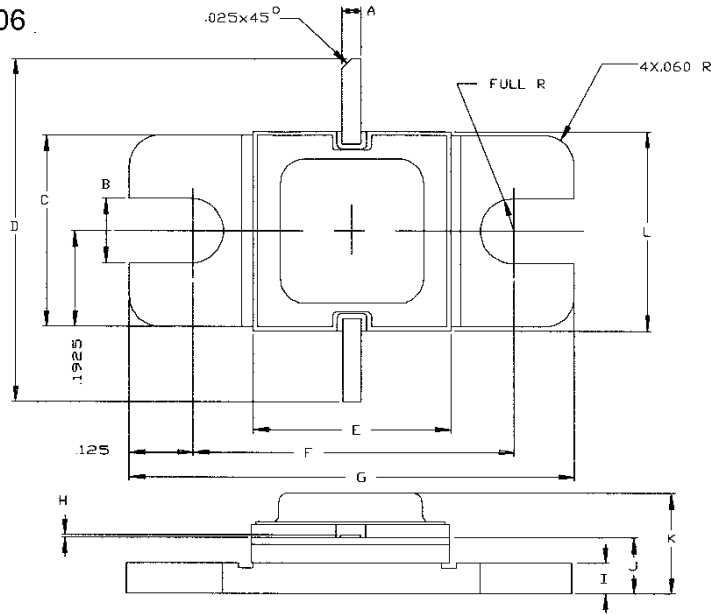
**THERMAL RESISTANCE vs  
PULSE WIDTH**

TYPICAL THERMAL RESISTANCE vs PULSE WIDTH



PACKAGE MECHANICAL DATA

Ref.: Dwg. No.12-0106



ADVANCED POWER TECHNOLOGY		CONT'D			
	MINIMUM Inches/mm	MAXIMUM Inches/mm		MINIMUM Inches/mm	MAXIMUM Inches/mm
A	.045/1,14	.055/1,40	K		.230/5,84
B	.125/3,18		L	.392/9,96	.402/10,29
C	.380/9,65	.390/9,91			
D	.710/18,03				
E	.392/9,96	.402/10,29			
F	.645/16,38	.655/16,64			
G	.895/22,73	.905/22,99			
H	.002/0,05	.006/0,15			
I	.055/1,40	.065/1,65			
J	.105/2,67	.125/3,18			